

PLEASE CHECK WWW.MOLEX.COM FOR LATEST PART INFORMATION

Part Number:

87831-0641

Status:

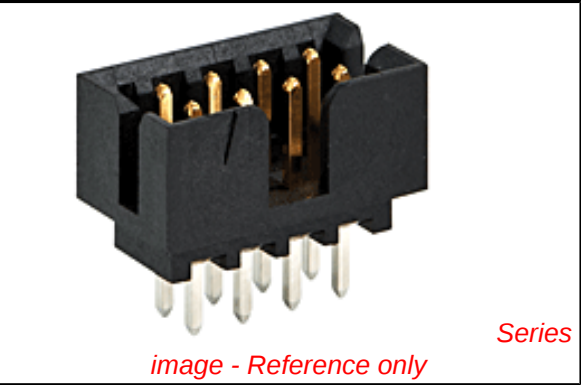
Active

Overview:

Milli-Grid™ Connector System

Description:

2.00mm Pitch Milli-Grid™ Header, Vertical, Through Hole, Shrouded, 6 Circuits, 0.38µm Gold (Au) Plating, with Locking Window, without PCB Locator, without Center Polarization Slot, Tube



Documents:

3D Model

Drawing (PDF)

Product Specification PS-87831-027 (PDF)

RoHS Certificate of Compliance (PDF)

Agency Certification		
CSA		LR19980
UL		E29179
General		
Product Family		PCB Headers
Series		87831
Application		Signal, Wire-to-Board
Comments		Contact Molex for application in automotive industry
Overview		Milli-Grid™ Connector System
Product Name		Milli-Grid™
UPC		822348271849
Physical		
Breakaway		No
Circuits (Loaded)		6
Circuits (maximum)		6
Color - Resin		Black
Durability (mating cycles max)		100
First Mate / Last Break		No
Flammability		94V-0
Glow-Wire Compliant		No
Guide to Mating Part		No
Keying to Mating Part		None
Lock to Mating Part		Yes
Material - Metal		Phosphor Bronze
Material - Plating Mating		Gold
Material - Plating Termination		Tin
Material - Resin		Nylon
Net Weight		0.314/g
Number of Rows		2
Orientation		Vertical
PC Tail Length		2.50mm
PCB Locator		No
PCB Retention		None
PCB Thickness - Recommended		1.60mm
Packaging Type		Tube
Pitch - Mating Interface		2.00mm
Pitch - Termination Interface		2.00mm
Plating min - Mating		0.381µm
Plating min - Termination		1.905µm
Polarized to PCB		No
Shrouded		Yes
Stackable		No
Surface Mount Compatible (SMC)		Yes

EU RoHS

ELV and RoHS Compliant

REACH SVHC

Contains SVHC: No

Low-Halogen Status

Not Low-Halogen

China RoHS



Need more information on product environmental compliance?

Email productcompliance@molex.com

For a multiple part number RoHS Certificate of Compliance, [click here](#)

Please visit the [Contact Us](#) section for any non-product compliance questions.

Search Parts in this Series

87831Series

Mates With

50394 Wire-to-Board Terminals, 51110 Wire-to-Board Crimp Housing, 87568 Wire-to-Board IDT Housings, 79107 Board-to-Board Top Entry Through Hole Receptacle, 79108 Board-to-Board FFC/FPC Top Entry Through Hole Receptacle, 79109 Board-to-Board Surface Mount PCB Receptacle

Temperature Range - Operating	-55°C to +105°C
Termination Interface: Style	Through Hole

Electrical

Current - Maximum per Contact	2A
Voltage - Maximum	125V

Solder Process Data

Duration at Max. Process Temperature (seconds)	10
Lead-free Process Capability	Wave Capable (TH only)
Max. Cycles at Max. Process Temperature	1
Process Temperature max. C	260

Material Info

Reference - Drawing Numbers

Product Specification	PS-87831-027
Sales Drawing	SD-87831-012

This document was generated on 03/23/2015

PLEASE CHECK WWW.MOLEX.COM FOR LATEST PART INFORMATION